

**MAXIMUM RATINGS**

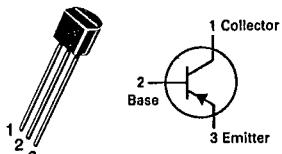
Rating	Symbol	BC 212	BC 213	BC 214	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	50	30	30	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	60	45	45	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>		5.0		Vdc
Collector Current - Continuous	I <sub>C</sub>		100		mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	350 2.8			mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.0 8.0			Watt mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>Stg</sub>	-55 to +150			°C

2

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	125	°C/W
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	357	°C/W

T-29-19

**BC212, A, B  
BC213, A, B, C  
BC214, B, C**
**CASE 29-04, STYLE 17  
TO-92 (TO-226AA)****AMPLIFIER TRANSISTORS**

PNP SILICON

Refer to BC307 for graphs.

**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)**

Characteristic	Type	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Collector-Emitter Breakdown Voltage (I <sub>C</sub> = 2.0 mA, I <sub>B</sub> = 0)	BC212 BC213 BC214	V <sub>(BR)CEO</sub>	50 30 30	— — —	— — —	Vdc
Collector-Base Breakdown Voltage (I <sub>C</sub> = 10 μA, I <sub>E</sub> = 0)	BC212 BC213 BC214	V <sub>(BR)CBO</sub>	60 45 45	— — —	— — —	Vdc
Emitter-Base Breakdown Voltage (I <sub>E</sub> = 10 μA, I <sub>C</sub> = 0)	BC212 BC213 BC214	V <sub>(BR)EBO</sub>	5 5 5	— — —	— — —	Vdc
Collector-Emitter Leakage Current (V <sub>CB</sub> = 30 V)	BC212 BC213 BC214	I <sub>CBO</sub>	— — —	— — —	15 15 15	nAdc
Emitter-Base Leakage Current (V <sub>EB</sub> = 4 V, I <sub>C</sub> = 0)	BC212 BC213 BC214	I <sub>EBO</sub>	— — —	— — —	15 15 15	nAdc
<b>ON CHARACTERISTICS</b>						
DC Current Gain (I <sub>C</sub> = 10 μA, V <sub>CE</sub> = 5 Vdc)	BC212 BC213 BC214	h <sub>FE</sub>	40 40 100	— — —	— — —	
(I <sub>C</sub> = 2 mA, V <sub>CE</sub> = 5 Vdc)	BC212 BC213 BC214		60 80 140	— — —	— — 600	
(I <sub>C</sub> = 100 mA, V <sub>CE</sub> = 5 Vdc)*	BC212, BC214 BC213		— —	120 140	— —	

MOTOROLA SMALL-SIGNAL TRANSISTORS, FETs AND DIODES

T-29-19

ELECTRICAL CHARACTERISTICS (continued) ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Type	Symbol	Min	Typ	Max	Unit
Collector-Emitter Saturation Voltage ( $I_C = 10 \text{ mA}_\text{dc}$ , $I_B = 0.5 \text{ mA}_\text{dc}$ ) ( $I_C = 100 \text{ mA}_\text{dc}$ , $I_B = 5 \text{ mA}_\text{dc}$ )*		$V_{CE(\text{sat})}$	—	0.10 0.25	— 0.6	Vdc
Base-Emitter Saturation Voltage ( $I_C = 100 \text{ mA}_\text{dc}$ , $I_B = 5 \text{ mA}_\text{dc}$ )		$V_{BE(\text{sat})}$	—	1.00	1.4	Vdc
Base-Emitter on Voltage ( $I_C = 2 \text{ mA}_\text{dc}$ , $V_{CE} = 5 \text{ Vdc}$ )		$V_{BE(\text{on})}$	0.6	0.62	0.72	Vdc

## DYNAMIC CHARACTERISTICS

Current-Gain Bandwidth Product ( $I_C = 10 \text{ mA}_\text{dc}$ , $V_{CE} = 5 \text{ Vdc}$ , $f = 50 \text{ MHz}$ )	BC212 BC214 BC213	$f_T$	— — —	280 320 360	— — —	MHz
Common-Base Output Capacitance ( $V_{CB} = 10 \text{ Vdc}$ , $I_C = 0$ , $f = \text{MHz}$ )		$C_{ob}$	—	—	6.0	pF
Noise Figure ( $I_C = 0.2 \text{ mA}_\text{dc}$ , $V_{CE} = 5 \text{ Vdc}$ , $R_S = 2 \text{ Kohms}$ , $f = 30 \text{ Hz}$ to $15 \text{ KHz}$ ) ( $I_C = 0.2 \text{ mA}_\text{dc}$ , $V_{CE} = 5 \text{ Vdc}$ , $R_S = 2 \text{ Kohms}$ , $f = 1 \text{ KHz}$ , $f = 200 \text{ Hz}$ )	BC214 BC213 BC212	NF	— — —	— — —	2 10 10	dB
Small Signal Current Gain ( $I_C = 2 \text{ mA}_\text{dc}$ , $V_{CE} = 5 \text{ Vdc}$ , $f = 1 \text{ KHz}$ )	BC212 BC213 BC214 BC212A, BC213A BC212B, BC213B, BC214B BC213C, BC214C	$h_{fe}$	60 80 140 100 200 200 350	— — — — — — —	300 400 400 600	

\*Pulse-test:  $T_p$  300 s, Duty-cycle 2%.